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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

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### **N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Features**

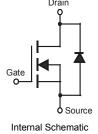
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

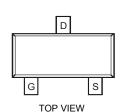
### **Mechanical Data**

- Case: SOT-23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (approximate)









Ordering Information (Note 4)

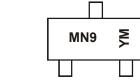
Part Number	Case	Packaging
DMN2041L-7	SOT-23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**





Shanghai A/T Site

MN9 = Product Type Marking Code

YM = Date Code Marking for SAT (Shanghai Assembly/ Test site) YM = Date Code Marking for CAT (Chengdu Assembly/ Test site) Y or  $\overline{Y}$  = Year (ex: A = 2013)

M = Month (ex: 9 = September)

Date Code Key

Date Code Noy												
Year	200	9	2010		2011	20	12	2013		2014	2	2015
Code	W		X		Υ	2	7	Α		В		С
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characte	eristic		Symbol	Value	Units
Drain-Source Voltage			V <sub>DSS</sub>	20	V
Gate-Source Voltage		V <sub>GSS</sub>	±12	V	
Continuous Drain Current (Note 5) Steady $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I <sub>D</sub>	6.4 4.5	А	
Pulsed Drain Current (Note 6)			I <sub>DM</sub>	30	Α

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	0.78	W
Thermal Resistance, Junction to Ambient @ T <sub>A</sub> = +25°C	$R_{\theta JA}$	161	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout.
- 6. Repetitive rating, pulse width limited by junction temperature.

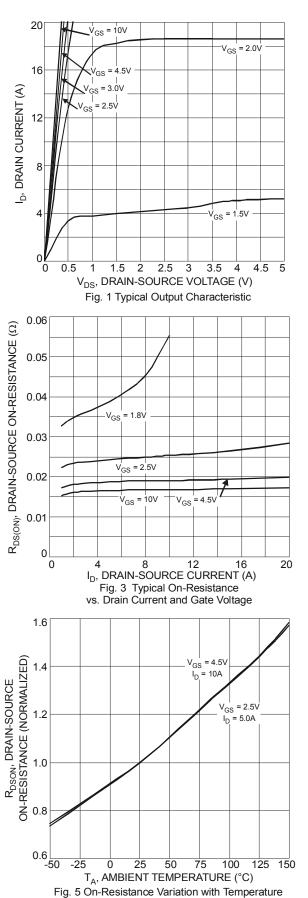
### Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

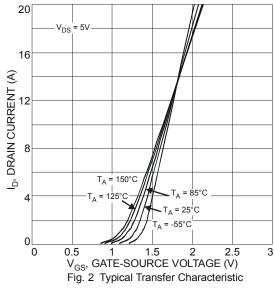
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 7)								
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	-	V	$V_{GS} = 0V, I_D = 250\mu A$		
Zero Gate Voltage Drain Current T <sub>J</sub> = 25°C	I <sub>DSS</sub>	_	_	1.0	μΑ	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V		
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	V <sub>GS</sub> = ±12V, V <sub>DS</sub> = 0V		
ON CHARACTERISTICS (Note 7)								
Gate Threshold Voltage	V <sub>GS(th)</sub>	0.5	_	1.2	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$		
Static Drain-Source On-Resistance	ם	_	20	28	mO.	$V_{GS} = 4.5V, I_D = 6.0A$		
Static Drain-Source On-Resistance	R <sub>DS (ON)</sub>		26	41	mΩ	V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 5.2A		
Forward Transfer Admittance	Y <sub>fs</sub>	_	6	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6A		
Diode Forward Voltage	$V_{SD}$	_	0.7	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 1.7A		
DYNAMIC CHARACTERISTICS (Note 8)								
Input Capacitance	C <sub>iss</sub>		550	-		V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1.0MHz		
Output Capacitance	Coss	-	88		pF			
Reverse Transfer Capacitance	C <sub>rss</sub>	_	81	_				
Gate Resistance	$R_g$	_	1.34	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$		
Total Gate Charge (10V)	$Q_g$	_	15.6	_	nC	$V_{GS} = 10V, V_{DS} = 10V, I_D = 6A$		
Total Gate Charge (4.5V)	$Q_g$	_	7.2	_				
Gate-Source Charge	$Q_{gs}$	_	1.0	_	nC	$V_{GS} = 4.5V$ , $V_{DS} = 10V$ , $I_{D} = 6A$		
Gate-Drain Charge	$Q_{gd}$	_	1.9	_				
Turn-On Delay Time	t <sub>D(on)</sub>	_	4.69	_				
Turn-On Rise Time	t <sub>r</sub>	_	13.19	_		$V_{DD}$ = 10V, $V_{GEN}$ = 4.5V, $R_{GEN}$ = 1 $\Omega$ , $I_{D}$ = 6.7A		
Turn-Off Delay Time	t <sub>D(off)</sub>	_	22.10	_	ns			
Turn-Off Fall Time	t <sub>f</sub>	_	6.43	_				

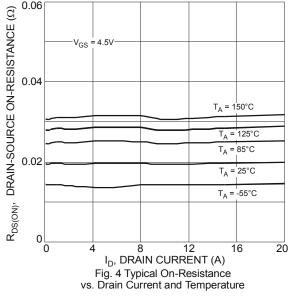
Notes:

- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to production testing.









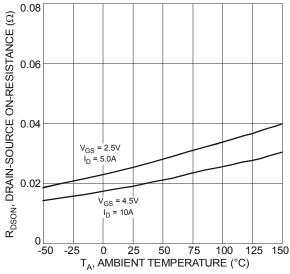
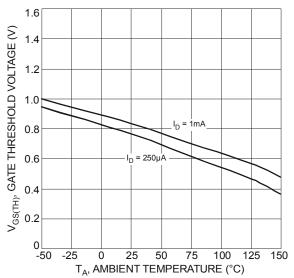


Fig. 6 On-Resistance Variation with Temperature





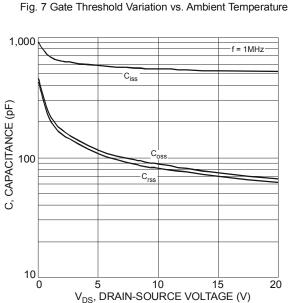
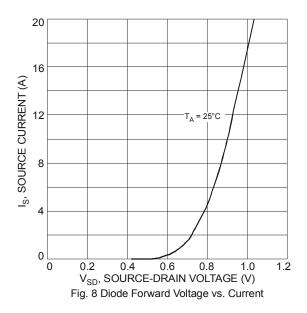


Fig. 9 Typical Total Capacitance



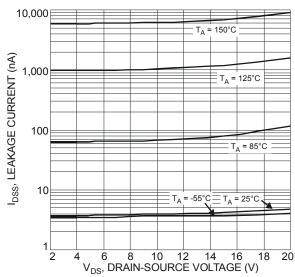


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage

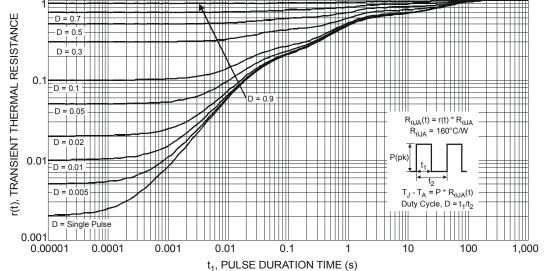
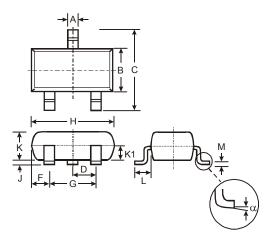


Fig. 11 Transient Thermal Response



## **Package Outline Dimensions**

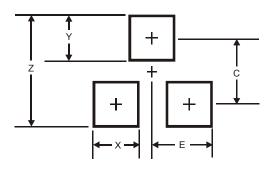
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT-23								
Dim	Min	Max	Тур						
Α	0.37	0.51	0.40						
В	1.20	1.40	1.30						
С	2.30	2.50	2.40						
D	0.89	1.03	0.915						
F	0.45	0.60	0.535						
G	1.78	2.05	1.83						
Н	2.80	3.00	2.90						
J	0.013	0.10	0.05						
K	0.903	1.10	1.00						
K1	1	ı	0.400						
L	0.45	0.61	0.55						
M	0.085	0.18	0.11						
α	0°	8°	-						
All	All Dimensions in mm								

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
E	1.35



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